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Features

- Provides ESD Protection per IEC 61000-4-2 Standard: Contact $\pm 10\text{kV}$
- 1 Channel of ESD Protection
- High Peak Pulse Current per IEC 61000-4-5 Standard
- Low Channel Input Capacitance
- Typically used in Cellular Handsets, Portable Electronics, Communication Systems, Computers and Peripherals
- **Totally Lead-Free & Fully RoHS Compliant (Notes 1 & 2)**
- **Halogen and Antimony Free. "Green" Device (Note 3)**

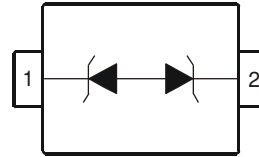
Mechanical Data

- Case: SOD523
- Case Material: Molded Plastic, "Green" Molding Compound; UL Flammability Classification Rating 94V-0
- Moisture Sensitivity: Level 1 per J-STD-020
- Terminals: Matte Tin Finish Annealed over Alloy 42 Leadframe (Lead-Free Plating). Solderable per MIL-STD-202, Method 208⁽³⁾
- Weight: 0.001 grams (Approximate)

SOD523



Top View



Device Schematic

Ordering Information (Note 4)

| Product | Compliance | Marking | Reel Size (inches) | Tape Width (mm) | Quantity per Reel |
|------------------------|------------|--------------|--------------------|-----------------|-------------------|
| DESD5V0U1BB-7 (Note 5) | Standard | K / \aleph | 7 | 8 | 3,000/Tape & Reel |

- Notes:
1. No purposely added lead. Fully EU Directive 2002/95/EC (RoHS) & 2011/65/EU (RoHS 2) compliant.
 2. See http://www.diodes.com/quality/lead_free.html for more information about Diodes Incorporated's definitions of Halogen- and Antimony-free, "Green" and Lead-free.
 3. Halogen- and Antimony-free "Green" products are defined as those which contain <900ppm bromine, <900ppm chlorine (<1500ppm total Br + Cl) and <1000ppm antimony compounds.
 4. For packaging details, go to our website at <http://www.diodes.com/products/packages.html>.
 5. Dispensed every other cavity of the carrier tape.

Marking Information

SOD523



K / \aleph = Product Type Marking Code

Maximum Ratings (@T_A = +25°C unless otherwise specified.)

| Characteristic | Symbol | Value | Unit | Conditions |
|------------------------------------|--------------------------|-------|------|------------------------|
| Peak Pulse Current | I _{PP} | 3 | A | 8/20μs, per Figure 3 |
| ESD Protection – Contact Discharge | V _{ESD_Contact} | ±10 | kV | IEC 61000-4-2 Standard |

Thermal Characteristics

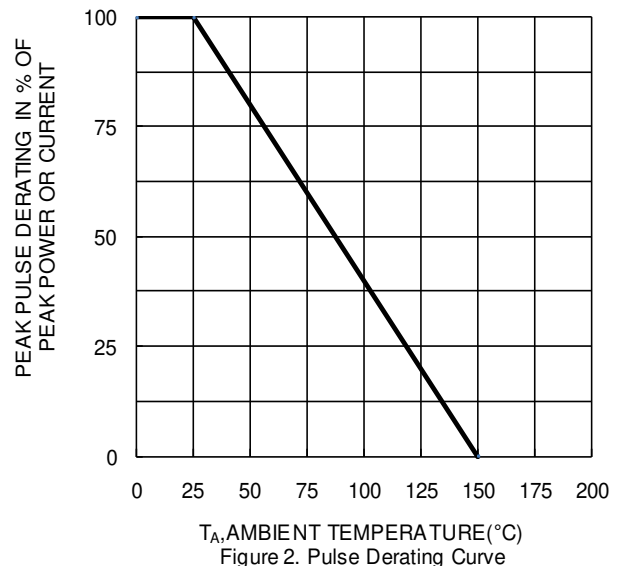
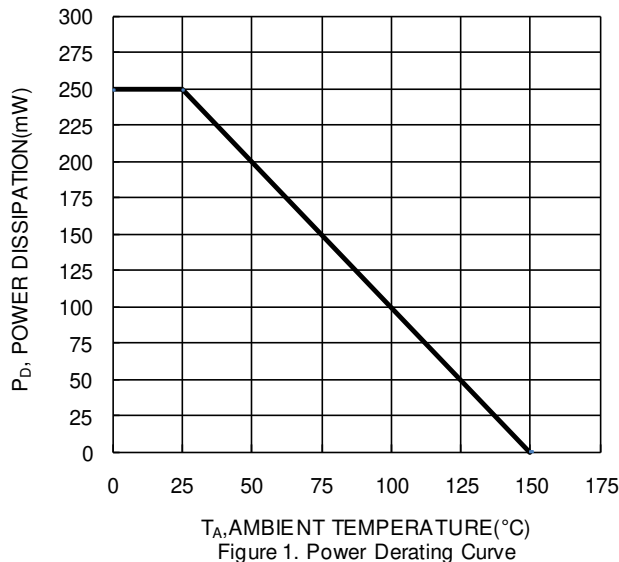
| Characteristic | Symbol | Value | Unit |
|--|-----------------------------------|-------------|------|
| Package Power Dissipation (Note 6) | P _D | 250 | mW |
| Thermal Resistance, Junction to Ambient (Note 6) | R _{θJA} | 500 | °C/W |
| Operating and Storage Temperature Range | T _J , T _{STG} | -65 to +150 | °C |

Electrical Characteristics @T_A = 25°C unless otherwise specified

| Characteristic | Symbol | Min | Typ | Max | Unit | Test Conditions |
|----------------------------------|------------------|-----|-----|-----|------|---|
| Reverse Standoff Voltage | V _{RWM} | - | - | 5 | V | - |
| Channel Leakage Current (Note 7) | I _{RM} | - | 5 | 100 | nA | V _{RWM} = 5V |
| Clamping Voltage | V _{CL} | - | 7.2 | - | V | I _{PP} = 3A, t _p = 8/20μs |
| Breakdown Voltage | V _{BR} | 5.5 | 7 | 9.5 | V | I _R = 5mA |
| Differential Resistance | R _{DIF} | - | - | 100 | Ω | I _R = 1mA |
| Dynamic Impedance | R _{dyn} | - | 0.3 | - | Ω | TLP, 20A, t _p = 100 ns |
| Channel Input Capacitance | C _T | - | 2.9 | - | pF | V _R = 0V, f = 1MHz |
| | | - | 1.9 | - | | V _R = 5V, f = 1MHz |

Notes: 6. Device mounted on FR-4 PCB pad layout (2oz copper) as shown on Diodes, Inc. suggested pad layout AP02001, which can be found on our website at <http://www.diodes.com>.

7. Short duration pulse test used to minimize self-heating effect.



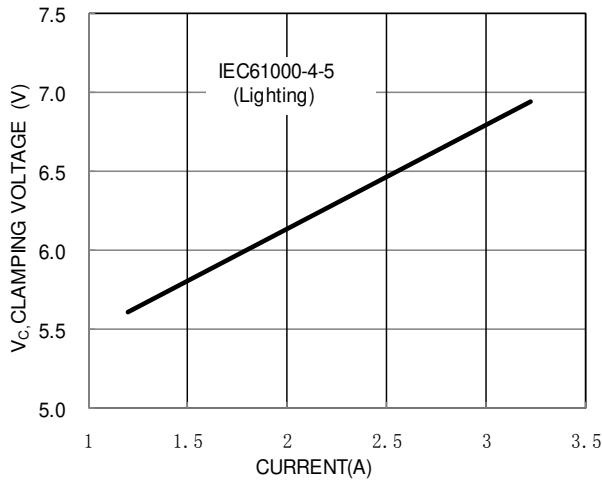


Figure 3. Clamping Voltage Characteristic

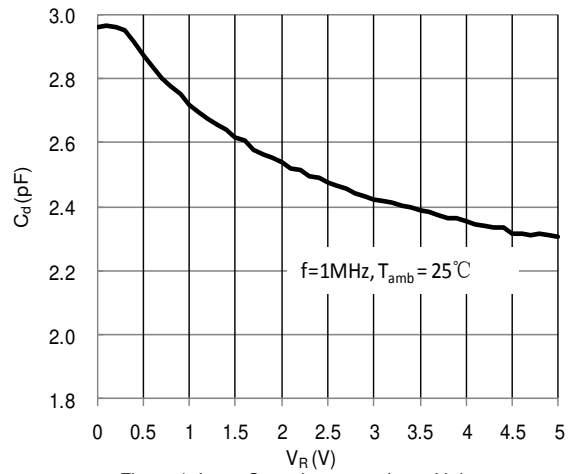


Figure 4. Input Capacitance vs. Input Voltage

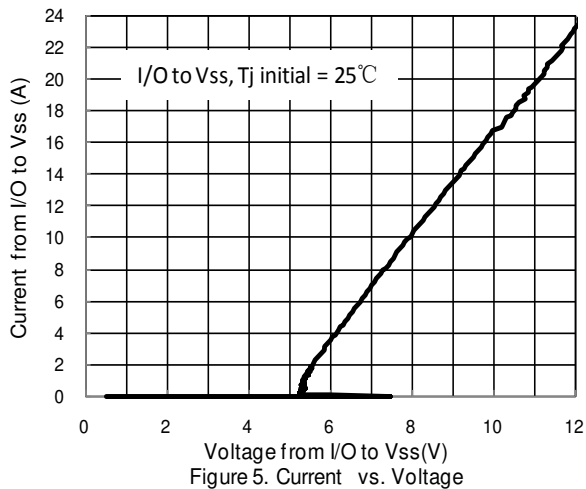


Figure 5. Current vs. Voltage

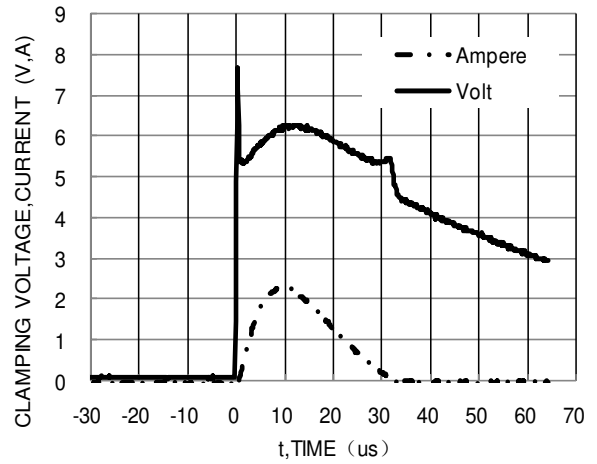


Figure 6. Waveform of Clamping Voltage, Current vs. Time(8/20us, I/O to Vss)

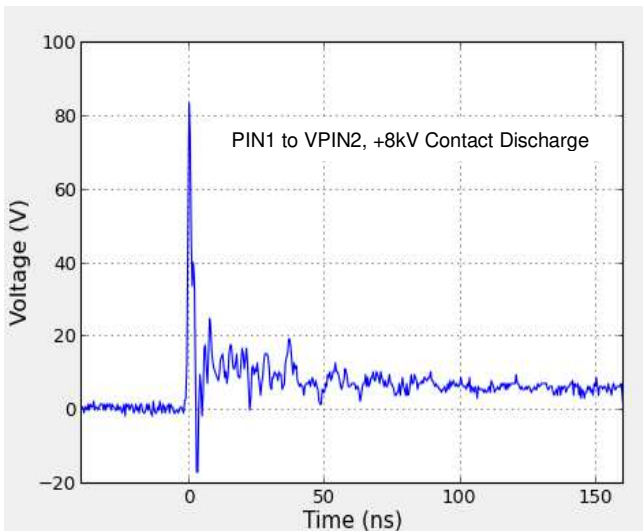


Figure 7 ESD response to IEC 61000-4-2

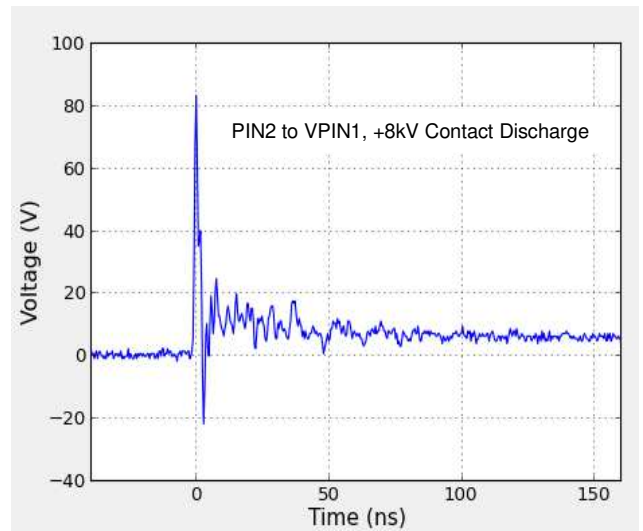
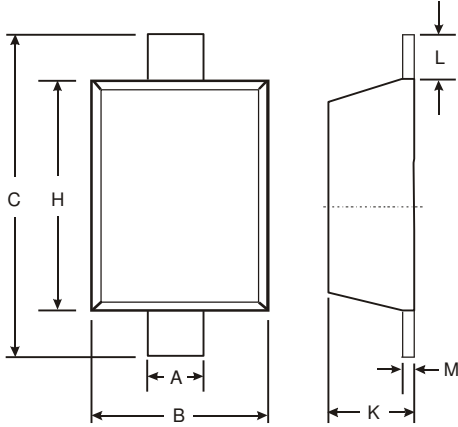


Figure 8 ESD response to IEC 61000-4-2

Package Outline Dimensions

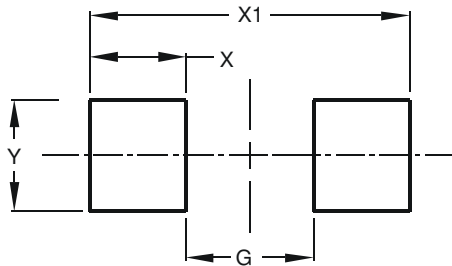
Please see AP02002 at <http://www.diodes.com/datasheets/ap02002.pdf> for the latest version.



| SOD523 | | |
|-----------------------------|------|------|
| Dim | Min | Max |
| A | 0.25 | 0.35 |
| B | 0.70 | 0.90 |
| C | 1.50 | 1.70 |
| H | 1.10 | 1.30 |
| K | 0.55 | 0.65 |
| L | 0.10 | 0.30 |
| M | 0.10 | 0.12 |
| All Dimensions in mm | | |

Suggested Pad Layout

Please see AP02001 at <http://www.diodes.com/datasheets/ap02001.pdf> for the latest version.



| Dimensions | Value (in mm) |
|------------|---------------|
| G | 0.80 |
| X | 0.60 |
| X1 | 2.00 |
| Y | 0.70 |

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